February 1985

OBJECTIVE
SPECIFICATIONS

Quad 2-Port Registers

Features

- **Function, pin-out, speed and drive compatibility with 54/74ALS logic family**
- **Low power consumption characteristic of CMOS**
- **High-Drive-Current outputs:**
  I_{OL} = 8 mA @ V_{OL} = 0.5V
- **Inputs and outputs interface directly with TTL, NMOS and CMOS devices**
- **Wide operating voltage range: 4.5V to 5.5V**
- **Characterized for operation over industrial and military temperature ranges:**
  74AHCT: −40°C to +85°C
  54AHCT: −55°C to +125°C

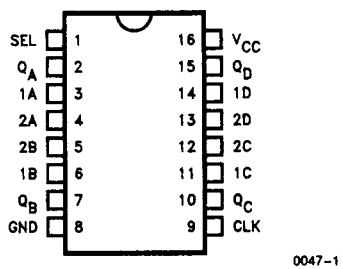
Description

These are high-speed quad 2-port registers. They are the logical equivalent of a quad 2-input multiplexer followed by a quad 4-bit edge-triggered register. A common select input (SEL) selects between two 4-bit input ports. The selected data is transferred to the output register on the low-to-high transition of the clock input.

Fabricated using Zytrex's proprietary ICE-MOS process, these devices provide speeds and drive capability equivalent to their ALSTTL counterparts and yet maintain CMOS power levels. The input and output voltage levels allow direct interface with TTL, NMOS and CMOS devices without any external components.

All inputs and outputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Pin Configuration



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Function Table

Inputs			Output
SEL	**Port 1**	**Port 2**	**Q**
l	l	X	L
l	h	X	H
h	X	l	L
h	X	h	H

l = Low Voltage Level one setup time prior to the low-to-high clock transition

h = High Voltage Level one setup time prior to the low-to-high clock transition

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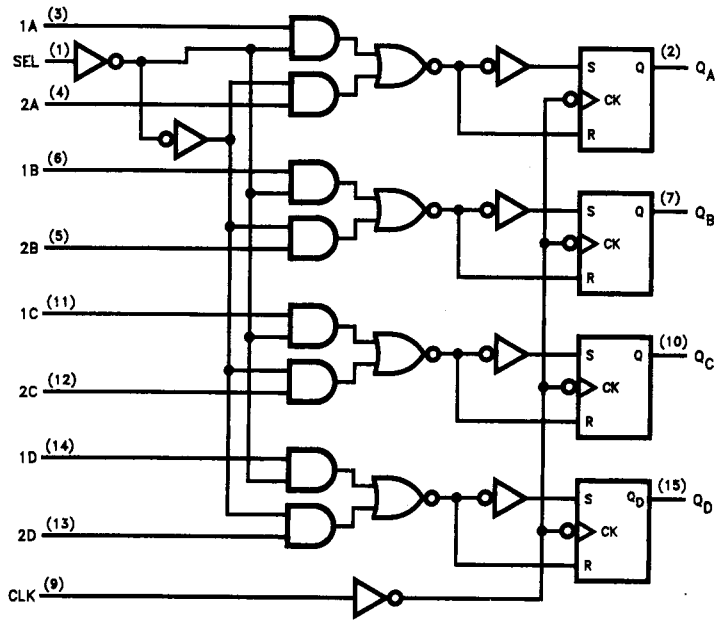
Logic Diagram



Absolute Maximum Ratings*

Supply Voltage Range, V_{CC} . . . . . −0.5V to 7V
DC Input Diode Current, I_{IK}
(V_I < −0.5V or V_I > V_{CC} + 0.5V) . . . . . ±20 mA
DC Output Diode Current, I_{OK}
(V_O < −0.5V or V_O > V_{CC} + 0.5V) . . . . . ±20 mA
Continuous Output Current Per Pin, I_O
(−0.5V < V_O < V_{CC} + 0.5V) . . . . . ±35 mA
Continuous Current Through
V_{CC} or GND pins . . . . . ±125 mA
Storage Temperature Range, T_{STG} . . −65°C to +150°C
Power Dissipation Per Package, P_D† . . . . . 500 mW

*Absolute Maximum Ratings are those values beyond which permanent damage to the device may occur. These are stress ratings only and functional operation of the device at or beyond them is not implied. Long exposure to these conditions may affect device reliability.

† Power Dissipation temperature derating:
Plastic Package (N): − 12 mW/°C from 65°C to 85°C
Ceramic Package (J): − 12 mW/°C from 100°C to 125°C

Recommended Operating Conditions

Supply Voltage, V_{CC} . . . . . 4.5V to 5.5V
DC Input & Output Voltages*, V_{IN}, V_{OUT} . . . . . 0V to V_{CC}
Operating Temperature
Range ZX74AHCT: −40°C to +85°C
ZX54AHCT: −55°C to +125°C
Input Rise & Fall Times, t_r, t_f . . . . . Max 500 ns

*Unused inputs must always be tied to an appropriate logic voltage level (either V_{CC} or GND)

DC Electrical Characteristics (V_{CC} = 5V ± 10% Unless Otherwise Specified)

Symbol	Parameter	Test Conditions	T_A = 25°C	74AHCT T_A = −40°C to +85°C	54AHCT T_A = −55°C to +125°C	Unit
			Typ	Guaranteed Limits		
V_{IH}	Minimum High-Level Input Voltage			2.0	2.0	2.0	V
V_{IL}	Maximum Low-Level Input Voltage			0.8	0.8	0.8	V
V_{OH}	Minimum High-Level Output Voltage	V_{IN} = V_{IH} or V_{IL} I_O = −20 μA I_O = −4 mA	V_{CC} 4.2	V_{CC} − 0.1 3.98	V_{CC} − 0.1 3.84	V_{CC} − 0.1 3.7	V
V_{OL}	Maximum Low-Level Output Voltage	V_{IN} = V_{IH} or V_{IL} I_O = 20 μA I_O = 4 mA I_O = 8 mA	0	0.1 0.26 0.39	0.1 0.33 0.5	0.1 0.4	V
I_{IN}	Maximum Input Current	V_{IN} = V_{CC} or GND		±0.1	±1.0	±1.0	μA
I_{CC}	Maximum Quiescent Supply Current	V_{IN} = V_{CC} or GND I_{OUT} = 0 μA		8.0	80.0	160.0	μA

AC Electrical Characteristics (Input t_r, t_f ≤ 2 ns), AHCT399

Symbol	Parameter		Conditions†	T_A = 25°C V_{CC} = 5.0V	74AHCT T_A = −40°C to +85°C V_{CC} = 5.0V ± 10%	54AHCT T_A = −55°C to +125°C V_{CC} = 5.0V ± 10%	Unit
				Typ	Guaranteed Limits		
t_{PLH}	Maximum Propagation Delay, CLK to Q or $\overline{Q}$		C_L = 50 pF	12	19	23	ns
t_{PHL}				12	19	23	
t_w	Minimum Pulse Width, CLK High or Low			6	10	15	ns
t_{su}	Minimum Setup Time	Data		6	10	15	ns
		Word Select		6	10	15	
t_h	Minimum Hold Time	Data		0	0	0	ns
		Word Select		0	0	0	
C_{IN}	Maximum Input Capacitance			5			pF
C_{PD}	Power Dissipation Capacitance*						pF

*C_{PD} determines the no-load dynamic power dissipation: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.
†For AC switching test circuits and timing waveforms see section 2.

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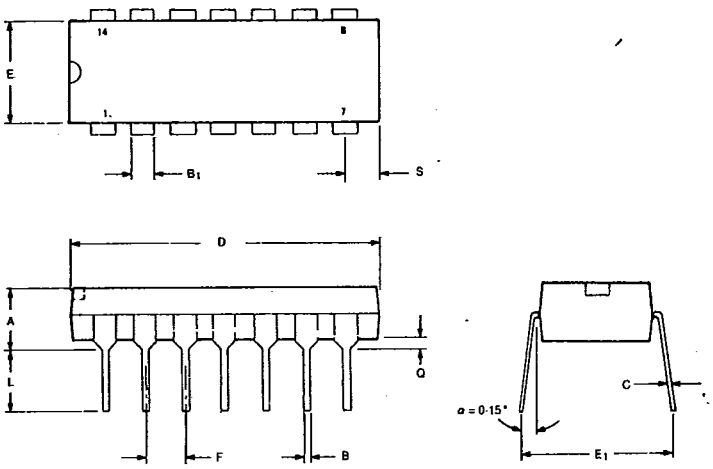
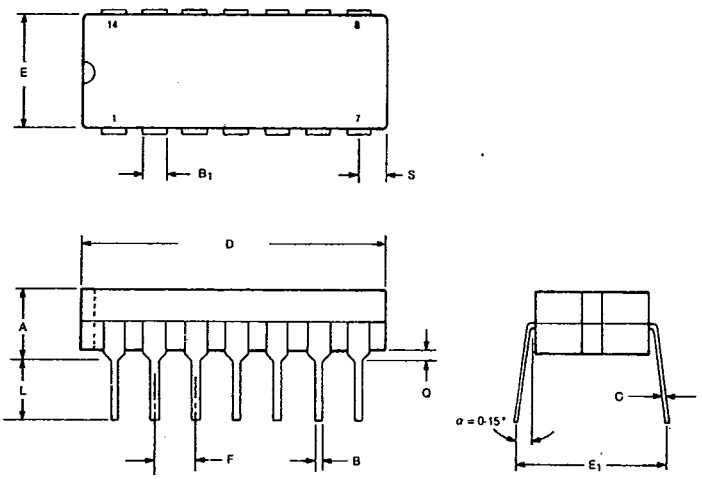
14-Pin Packages

Plastic Package



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	3.81	5.08	0.150	0.200
B	0.38	0.58	0.015	0.023
B_1	1.40	1.78	0.055	0.070
C	0.20	0.38	0.008	0.015
D	18.16	19.56	0.715	0.770
E	6.10	7.49	0.240	0.295
E_1	7.62	10.03	0.300	0.395
F	2.54		0.100	
L	3.18	4.19	0.125	0.165
Q	0.51	1.02	0.020	0.040
S	1.91	2.29	0.075	0.090

Ceramic Package



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	—	5.08	—	0.200
B	0.38	0.58	0.015	0.023
B_1	1.40	1.78	0.055	0.070
C	0.20	0.38	0.008	0.015
D	19.05	19.94	0.750	0.785
E	6.10	7.49	0.240	0.295
E_1	7.62	10.03	0.300	0.395
F	2.54		0.100	
L	3.18	4.19	0.125	0.165
Q	0.51	1.02	0.020	0.040
S	1.91	2.29	0.075	0.090

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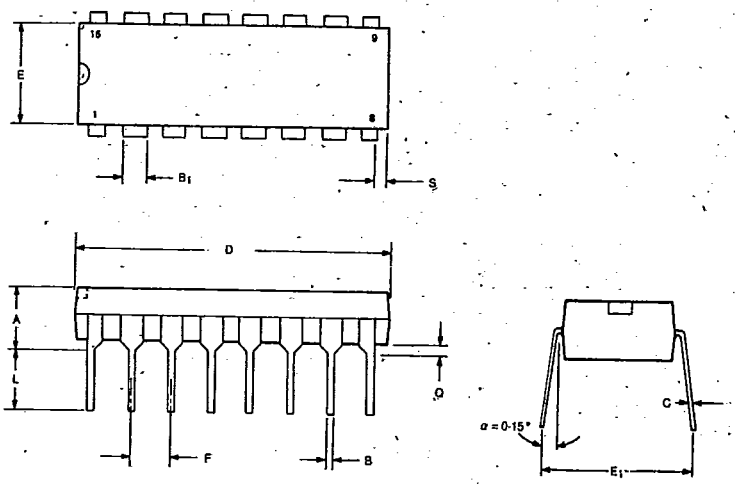
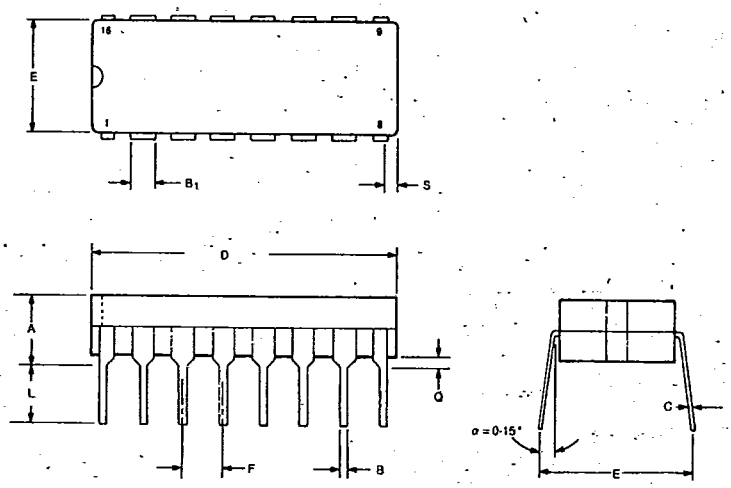
16-Pin Packages

Plastic Package



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	3.81	4.32	0.150	0.170
B	0.38	0.58	0.015	0.023
B_1	1.40	1.78	0.055	0.070
C	0.20	0.38	0.008	0.015
D	19.05	19.94	0.750	0.785
E	6.10	7.49	0.240	0.295
E_1	7.62	8.89	0.300	0.350
F	2.54		0.100	
L	3.18	4.19	0.125	0.165
Q	0.51	1.02	0.020	0.040
S	1.91	2.29	0.075	0.090

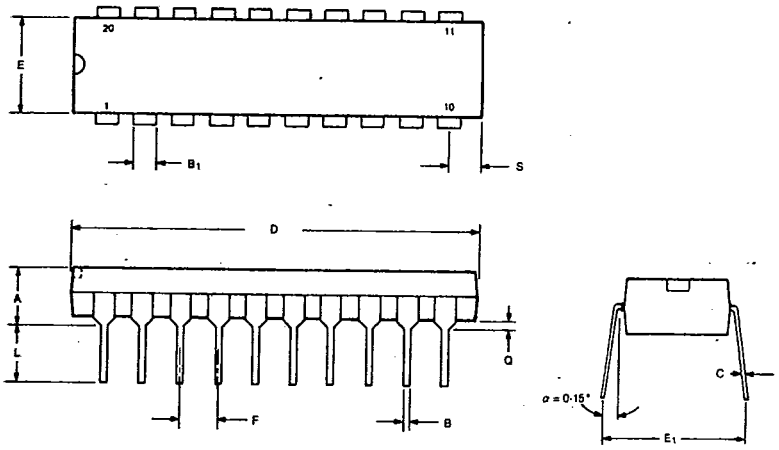
Ceramic Package



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	—	5.08	—	0.200
B	0.38	0.58	0.015	0.023
B_1	1.40	1.78	0.055	0.070
C	0.20	0.38	0.008	0.015
D	19.05	19.94	0.750	0.785
E	6.10	7.49	0.240	0.295
E_1	7.62	10.03	0.300	0.395
F	2.54		0.100	
L	3.18	4.19	0.125	0.165
Q	0.51	1.02	0.020	0.040
S	1.51	1.14	0.020	0.045

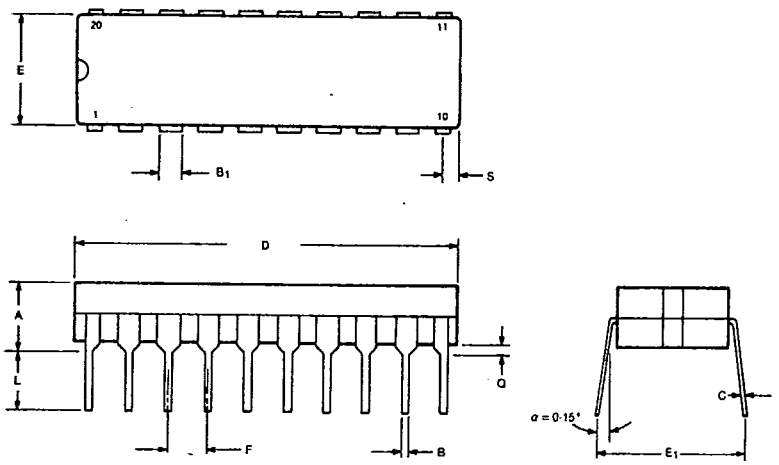
20-Pin Packages

Plastic Package



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	4.06	5.08	0.160	0.200
B	0.38	0.53	0.015	0.021
B_1	1.14	1.52	0.045	0.060
C	0.20	0.38	0.008	0.015
D	25.65	27.18	1.010	1.070
E	6.10	6.60	0.240	0.260
E_1	7.77	8.89	0.306	0.350
F	2.54		0.100	
L	3.30	4.01	0.130	0.158
Q	0.38	0.89	0.015	0.035
S	1.85	1.93	0.073	0.076

Ceramic Package



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	4.06	5.08	0.160	0.200
B	0.38	0.53	0.015	0.021
B_1	1.14	1.52	0.045	0.060
C	0.20	0.38	0.008	0.015
D	25.78	25.93	1.015	1.021
E	6.10	6.60	0.240	0.260
E_1	7.77	7.98	0.306	0.314
F	2.54		0.100	
L	3.73	4.01	0.147	0.158
Q	0.38	0.89	0.015	0.035
S	0.51	1.14	0.020	0.045

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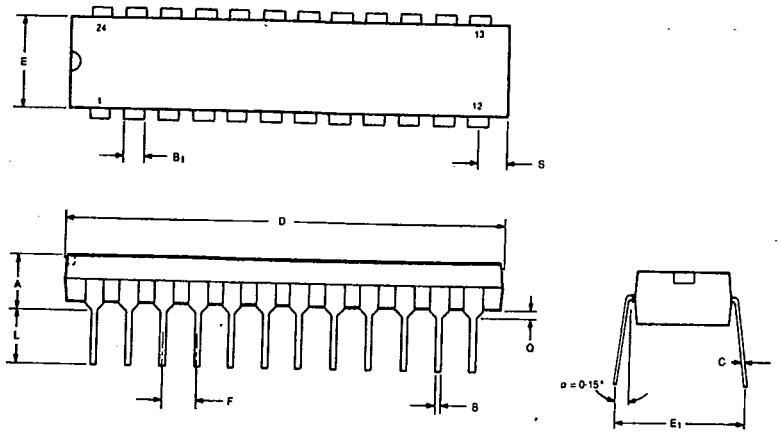
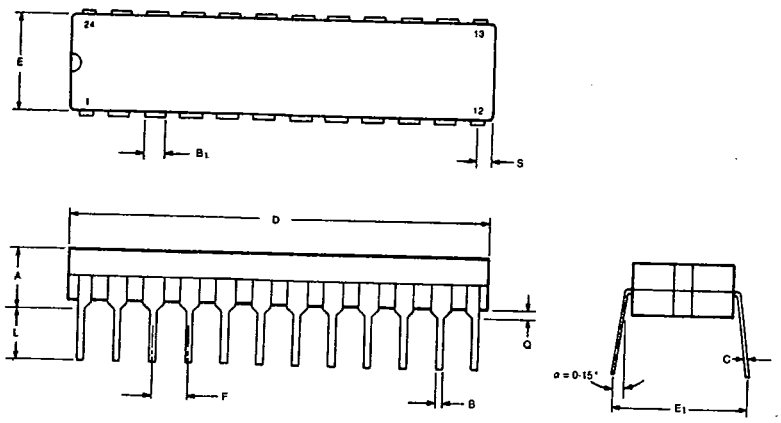
24-Pin Packages

Plastic Package



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	4.06	5.08	0.160	0.200
B	0.38	0.53	0.015	0.021
B_1	1.14	1.52	0.045	0.060
C	0.20	0.38	0.008	0.015
D	31.24	32.13	1.230	1.265
E	6.10	6.60	0.240	0.260
E_1	7.77	8.89	0.306	0.350
F	2.54		0.100	
L	3.30	4.01	0.130	0.158
Q	0.38	0.89	0.015	0.035
S	0.51	1.14	0.020	0.045

Ceramic Package



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	4.06	5.08	0.160	0.200
B	0.38	0.53	0.015	0.021
B_1	1.14	1.52	0.045	0.060
C	0.20	0.38	0.008	0.015
D	31.50	32.64	1.240	1.285
E	7.24	7.75	0.285	0.305
E_1	7.77	7.98	0.306	0.314
F	2.54		0.100	
L	3.73	4.01	0.147	0.158
Q	0.508	1.778	0.020	0.070
S	1.85	1.93	0.073	0.076